04.00
$02-08-0$

Docket: 6739

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: John G. Spakousky

Serial No.:   09/758,845

Filing Date: January 11, 2001

Title: **Composite Building Block With Modular Connective Structure**

Information Disclosure Statement Filed Under 37 CFR §1.97(b)(3)

Assistant Commissioner for Patents
Washington D.C. 20231

Dear Sir:

(1) Information Disclosure Statement

Pursuant to 37 C.F.R. §1.56, the references listed on the attached form PTO-1449 (3 sheets,

submitted in duplicate) are being brought to the attention of the Examiner for consideration in

connection with the examination of the above identified patent application.

(2) Statement Under 37 CFR §1.98(d)

Copies of the references cited by Applicant are not enclosed herewith, pursuant to 37 CFR

§1.98(d). Each item on the enclosed PTO-1449 forms was cited by the Applicant and/or the

I hereby certify that the document is being
deposited with the United States Postal Service as
first class mail in an envelope addressed to:
Assistant Commissioner for Patents, Washington,
D.C. 20231 on

5 February 2001
_____
(Date of Deposit)

Jeannie Rapstad
_____
(Name)

_____
Signature

Page 1 of 2

Office in one or more of the following prior related cases:

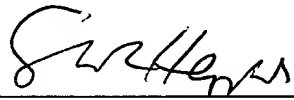08/795,691 filed February 4, 1997, now U.S. Patent No. 5,983,585; and

9/390,435 filed September 7, 1999.

Pursuant to the Manual of Patent Examining Procedure, Chapter 609, applicant requests that the Examiner consider each of the listed documents and initial and return to the undersigned a copy of the enclosed Form PTO-1449 (submitted in duplicate).

It is believed that no fees are due in connection with this communication. However, the Office is hereby authorized to charge any deficiency, or credit any overpayment to Deposit Account 04-1420.

Respectfully submitted,

Date: _Feb 5, 2001_   By _[signature]_

Stuart R. Hemphill
Registration No. 28,084
Dorsey & Whitney
Pillsbury Center South
220 South Sixth Street
Minneapolis, Minnesota 55402-1498
Telephone: 612-340-2734

Attorney for Applicant